

General Description

The 2SB1202 is PNP silicon power transistor, Designed for general purpose amplifier and low speed switching applications.

Features

- Epitaxial Planar Die Construction
- Low Collector-Emitter Saturation Voltage
- RoHS Compliant

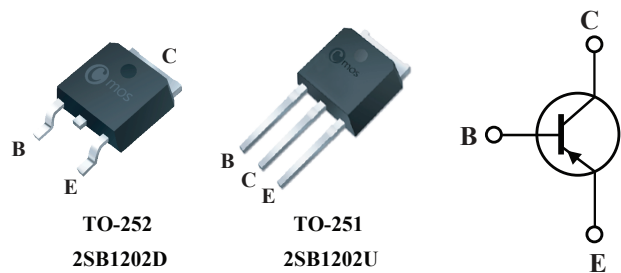
Product Summary

VCBO	VCEO	IC
-60V	-50V	-3A

Applications

- Ideal for Medium Power Switching

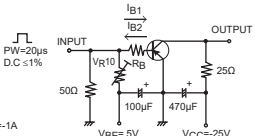
TO-252/251 Pin Configuration



Absolute Maximum Ratings(Ta = 25°C)

Symbol	Parameter	Rating	Units
V _{CB0}	Collector to Base Voltage	-60	V
V _{CE0}	Collector to Emitter Voltage	-50	V
V _{EB0}	Emitter-Base Voltage	-6	V
I _C	Collector Current	-3	A
I _{CP}	Collector Current (Pulse)	-6	A
P _C	Collector Dissipation(T _c =25°C)	20	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Junction Temperature	150	°C

Electrical Characteristics (T_a =25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit	
Collector Cutoff Current	I _{CBO}	V _{CB} =-40V, I _E =0A			-1	μA	
Emitter Cutoff Current	I _{EBO}	V _{EB} =-5V, I _C =0A			-1	μA	
DC Current Gain	h _{FE}	V _{CE} =-2V, I _C =-5mA	100*		560*		
Gain-Bandwidth Product	f _T	V _{CE} =-5V, I _C =-1A		150		MHz	
Output Capacitance	C _{ob}	V _{CB} =-10V, f=1MHz		39		pF	
Collector-to-Emitter Saturation Voltage	V _{CE(sat)}	I _C =-2A, I _B =-200mA		-0.22	-0.6	V	
Base-to-Emitter Saturation Voltage	V _{BE(sat)}	I _C =-1A, I _B =-100mA		-0.9	-1.5	V	
Collector-to-Base Breakdown Voltage	V _{(BR)CBO}	I _C =-2mA, I _E =0A	-60			V	
Collector-to-Emitter Breakdown Voltage	V _{(BR)CEO}	I _C =-2mA, R _{BE} =∞	-50			V	
Emitter-to-Base Breakdown Voltage	V _{(BR)EBO}	I _E =-10μA, I _C =0A	-6			V	
Turn-ON Time	t _{on}	 <p style="text-align: center;">-10I_{B1} = 10I_{B2} = I_C = -1A</p>		70		ns	
Storage Time	t _{stg}				450		ns
Fall Time	t _f				35		ns

*The 2SB1202 are classified by 100mA h_{FE} as follows :

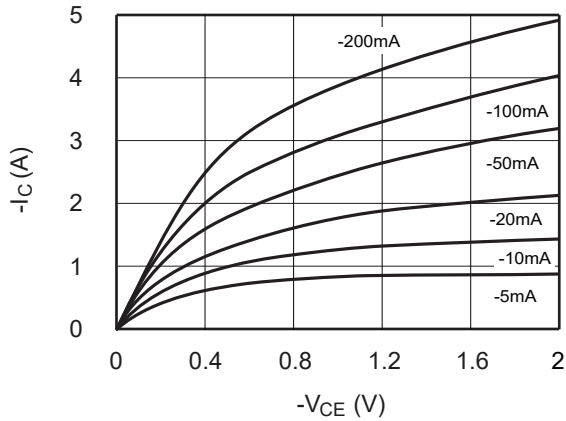
Rank	Q	R	S	T
h _{FE}	100 to 200	140 to 280	200 to 400	280 to 560

This product has been designed and qualified for the consumer market.

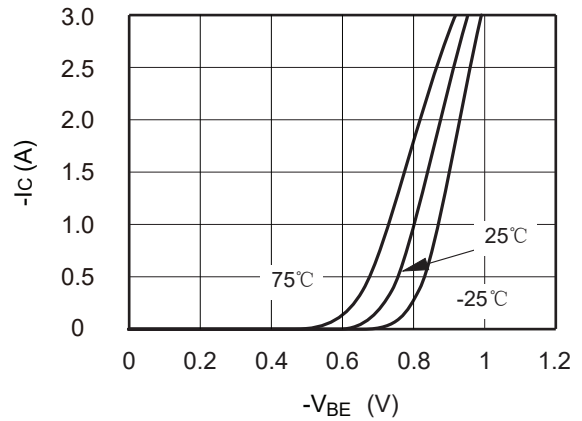
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Cmos reserves the right to improve product design, functions and reliability without notice. Please refer to the latest version of specification.

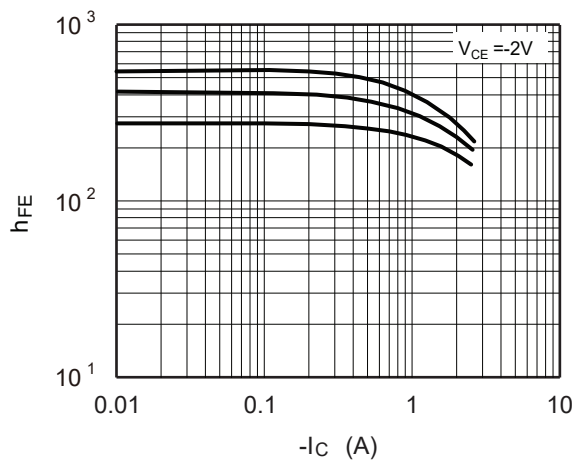
Typical Characteristics



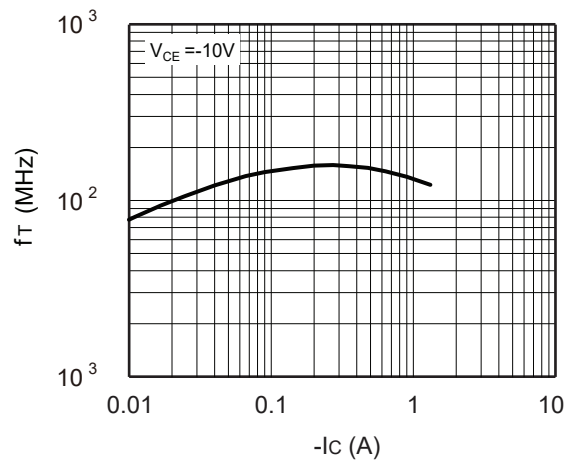
Grounded emitter output characteristics



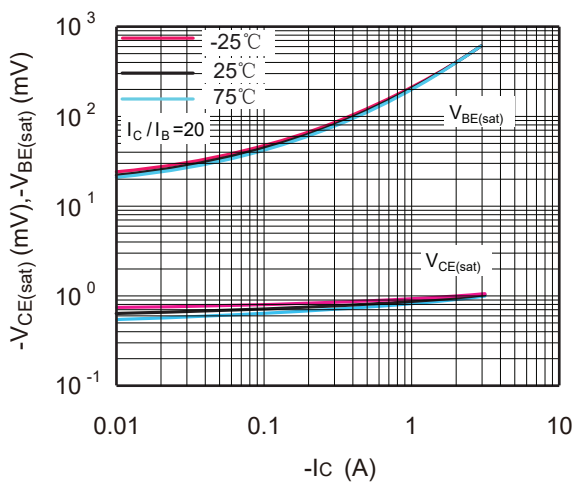
Grounded emitter propagation characteristics



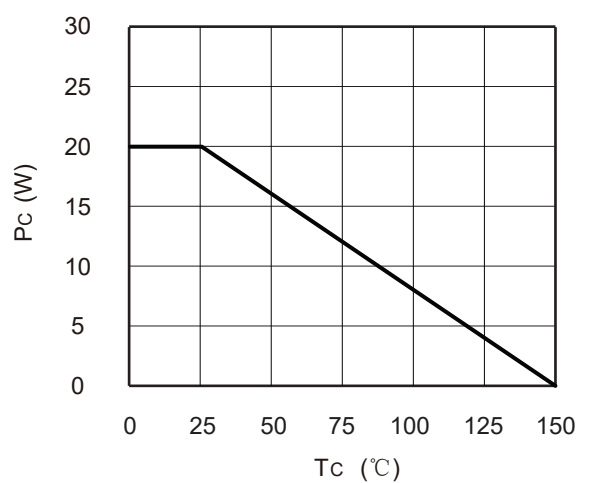
DC current gain vs. collector current



Gain bandwidth product vs. emitter current



Collector-emitter saturation voltage vs. collector current
Base-emitter saturation voltage vs. collector current

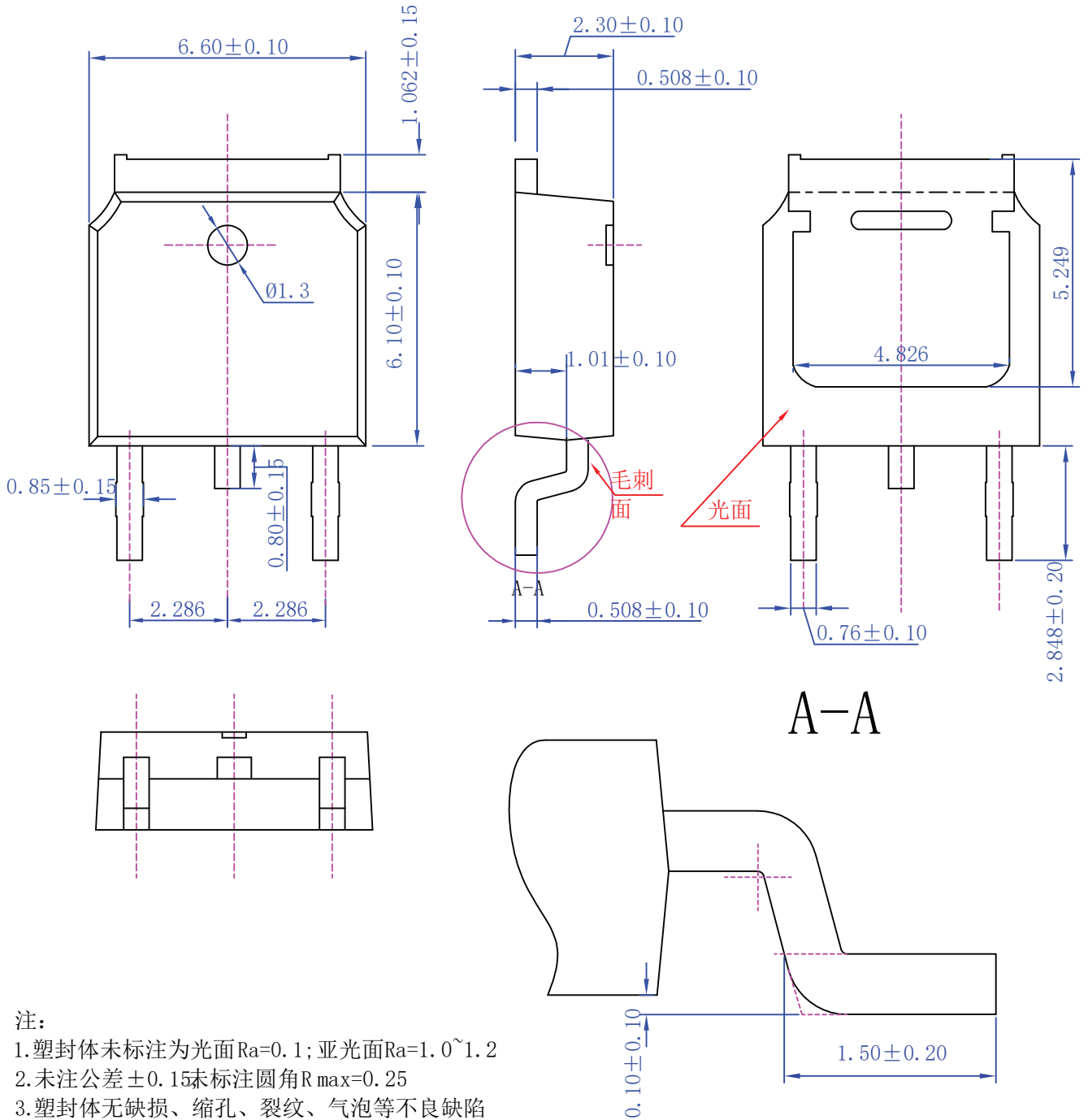


Maximum Collector Dissipation Curve

Package Dimension

TO-252

Unit :mm



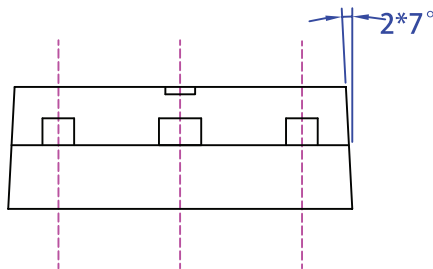
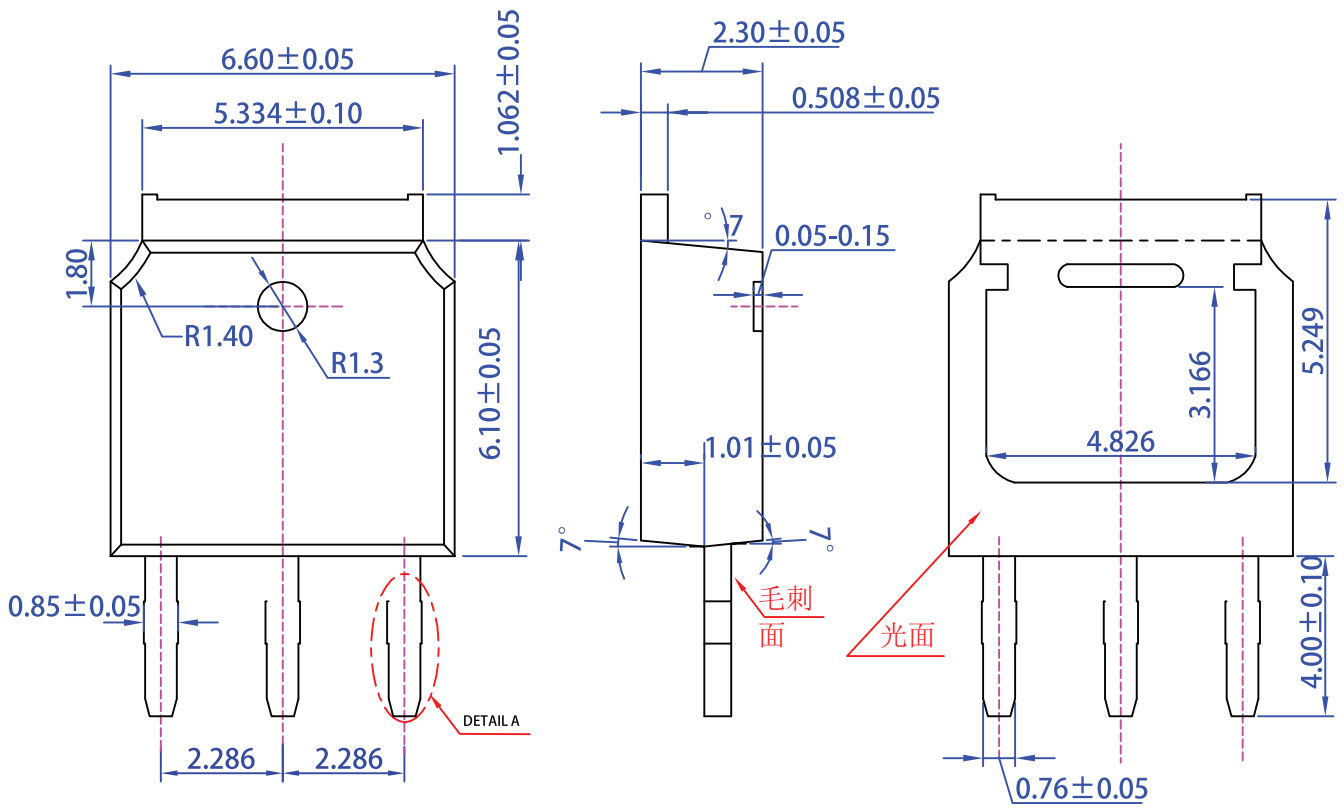
注:

1. 塑封体未标注为光面Ra=0.1; 亚光面Ra=1.0~1.2
2. 未注公差±0.15未标注圆角R max=0.25
3. 塑封体无缺损、缩孔、裂纹、气泡等不良缺陷
4. 标注单位mm
5. 顶针孔不允许凸出塑封体表面

Package Dimension

TO-251A

Unit :mm



DETAIL A
 $0 < A1 \text{ or } A2 < 0.05$

